

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	5636	(250/492.24,396,492.1,492.21, 492.22,492.3).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/19 16:50
L2	10384	pyroelectric\$4 or pyro-electric\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 16:51
L3	310	I2 and ((pyroelectric\$4 or pyro-electric\$4) near4 plate)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:53
L4	78	I3 and dielectric\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:53
L5	63	I4 and heat\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 16:53
L6	38	I5 and (magnet\$4 or electromagnet\$4 or electro-magnet\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 16:53
L7	36	I6 and (substrate or wafer or sample)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 16:54
L8	30	I7 and (hold\$4 or stage or table)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 16:55

L9	5	I8 and deflect\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 16:55
L10	8	I8 and hold\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:24
L11	8	I10 and I8	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 16:56
L12	3	I10 and I9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 16:56
L13	0	("6815681").URPN.	USPAT	OR	ON	2005/05/19 17:17
L14	11	("20020012860" "20020173126" "20030006381" "4139444" "5293041" "5822175" "6162535" "6207554" "6476402" "6479924" "6566666").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/19 17:17
L15	1	I10 and sapphire	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:25
L16	1	I8 and sapphire	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:25
L17	23	I8 and electron	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:26

L18	18	I7 and adhes\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:26
L19	1	I18 and sapphire	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:26
L20	1	I18 and (sapphire or saphire)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:27
L21	15	I18 and silicon	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:28
L22	15	I21 and (adhesive or adhesion)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:34
L23	1	I22 and lens	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:28
L24	7	I22 and (infrared or IR)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:32
L25	4	I24 and (resist or photoresist)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:29

L26	1	I24 and (mask or reticle)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:30
L27	4	I24 and pattern\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:30
L28	1	I22 and I1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:35
L29	94	(dong-wook near kim) or (In-kyeong near Yoo) or (chang-wook near Moon)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:36
L30	1	I29 and I22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:36
L31	6	I7 and deflect\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:37
L32	6	I31 and (lens or focus\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:37
L33	1	I32 and (sapphire or saphire)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:39

L34	5	I7 and (method with (mak\$3 or manufatur\$4 or fabricat\$4) with (pyroelectric\$4 or pyro-electric\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:52
L35	26	I7 and electron	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:42
L36	1	I35 and (sapphire or saphire)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 18:01
L37	317	(method with (mak\$3 or manufatur\$4 or fabricat\$4) with (pyroelectric\$4 or pyro-electric\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:52
L38	97	I37 and dielectric\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:53
L39	97	I38 and ((pyroelectric\$4 or pyro-electric\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:53
L40	36	I38 and ((pyroelectric\$4 or pyro-electric\$4)near4 (plate or layer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:55
L41	28	I40 and film	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:55

L42	6	I41 and (resist or photoresist)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:56
L43	5	I42 and (mask or reticle or rectile)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 17:57
L44	3	I40 and (sapphire or saphire)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/19 18:02